



RF360  
Europe GmbH

## SAW components

### SAW Rx filter

LTE band 20

Series/type: B8814  
Ordering code: B39811B8814P810

Date: August 23, 2016  
Version: 2.2

RF360 products mentioned within this document are products of RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the "RF360 Subsidiaries").

RF360 Europe GmbH, Anzinger Str. 13, München, Germany

© 2019 RF360 Europe GmbH and/or its affiliated companies. All rights reserved.

These materials, including the information contained herein, may be used only for informational purposes by the customer. The RF360 Subsidiaries assume no responsibility for errors or omissions in these materials or the information contained herein. The RF360 Subsidiaries reserve the right to make changes to the product(s) or information contained herein without notice. The materials and information are provided on an AS IS basis, and the RF360 Subsidiaries assume no liability and make no warranty or representation, either expressed or implied, with respect to the materials, or any output or results based on the use, application, or evaluation of such materials, including, without limitation, with respect to the non-infringement of trademarks, patents, copyrights or any other intellectual property rights or other rights of third parties.

No use of this documentation or any information contained herein grants any license, whether express, implied, by estoppel or otherwise, to any intellectual property rights, including, without limitation, to any patents owned by QUALCOMM Incorporated or any of its subsidiaries.

Not to be used, copied, reproduced, or modified in whole or in part, nor its contents revealed in any manner to others without the express written permission of RF360 Europe GmbH.

Qualcomm is a trademark of Qualcomm Incorporated, registered in the United States and other countries. Other product and brand names may be trademarks or registered trademarks of their respective owners.

This technical data may be subject to U.S. and international export, re-export, or transfer ("export") laws. Diversion contrary to U.S. and international law is strictly prohibited.



## SAW components

### SAW Rx filter LTE band 20

Series/type:	B8814
Ordering code:	B39811B8814P810
Date:	August 23, 2016
Version:	2.2

© EPCOS AG 2016. Reproduction, publication and dissemination of this data sheet, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.

EPCOS AG is a TDK Group Company.

SAW components	B8814
SAW Rx filter	806

Data sheet

**Table of contents**

1 <a href="#">Application</a> .....	3
2 <a href="#">Features</a> .....	3
3 <a href="#">Package</a> .....	4
4 <a href="#">Pin configuration</a> .....	4
5 <a href="#">Matching circuit</a> .....	5
6 <a href="#">Characteristics</a> .....	6
7 <a href="#">Maximum ratings</a> .....	7
8 <a href="#">Transmission coefficient</a> .....	8
9 <a href="#">Reflection coefficients</a> .....	9
10 <a href="#">Packing material</a> .....	10
11 <a href="#">Marking</a> .....	14
12 <a href="#">Soldering profile</a> .....	15
13 <a href="#">Annotations</a> .....	16
14 <a href="#">Cautions and warnings</a> .....	17
<a href="#">Important notes</a> .....	18

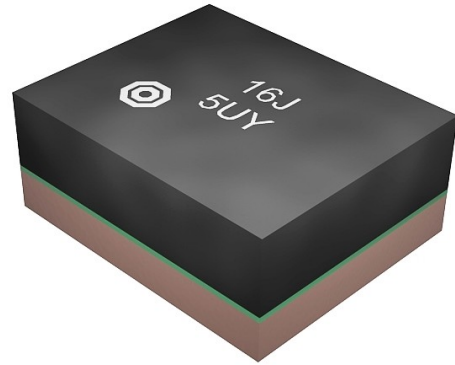
Data sheet

## 1 Application

- Low-loss RF filter for LTE band 20, Rx path
- Usable pass band: 30 MHz

## 2 Features

- Package size 1.1±0.1 mm × 0.9±0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 1 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

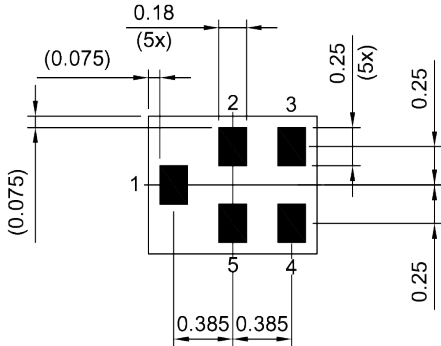


**Figure 1:** Picture of component with example of product marking.

Data sheet

**3 Package**

BOTTOM VIEW

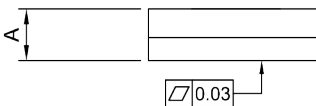


Pad and pitch tolerance ±0.05

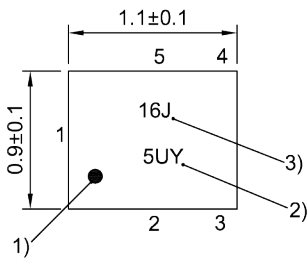
**4 Pin configuration**

- 1            Input (or Output)
- 4            Output (or Input)
- 2, 3, 5      Ground

SIDE VIEW

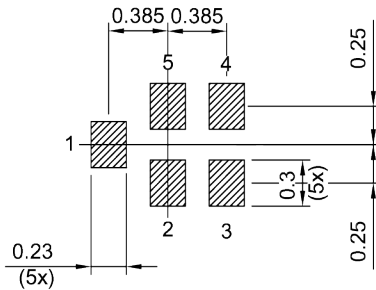


TOP VIEW



- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number

Land pattern THRU VIEW



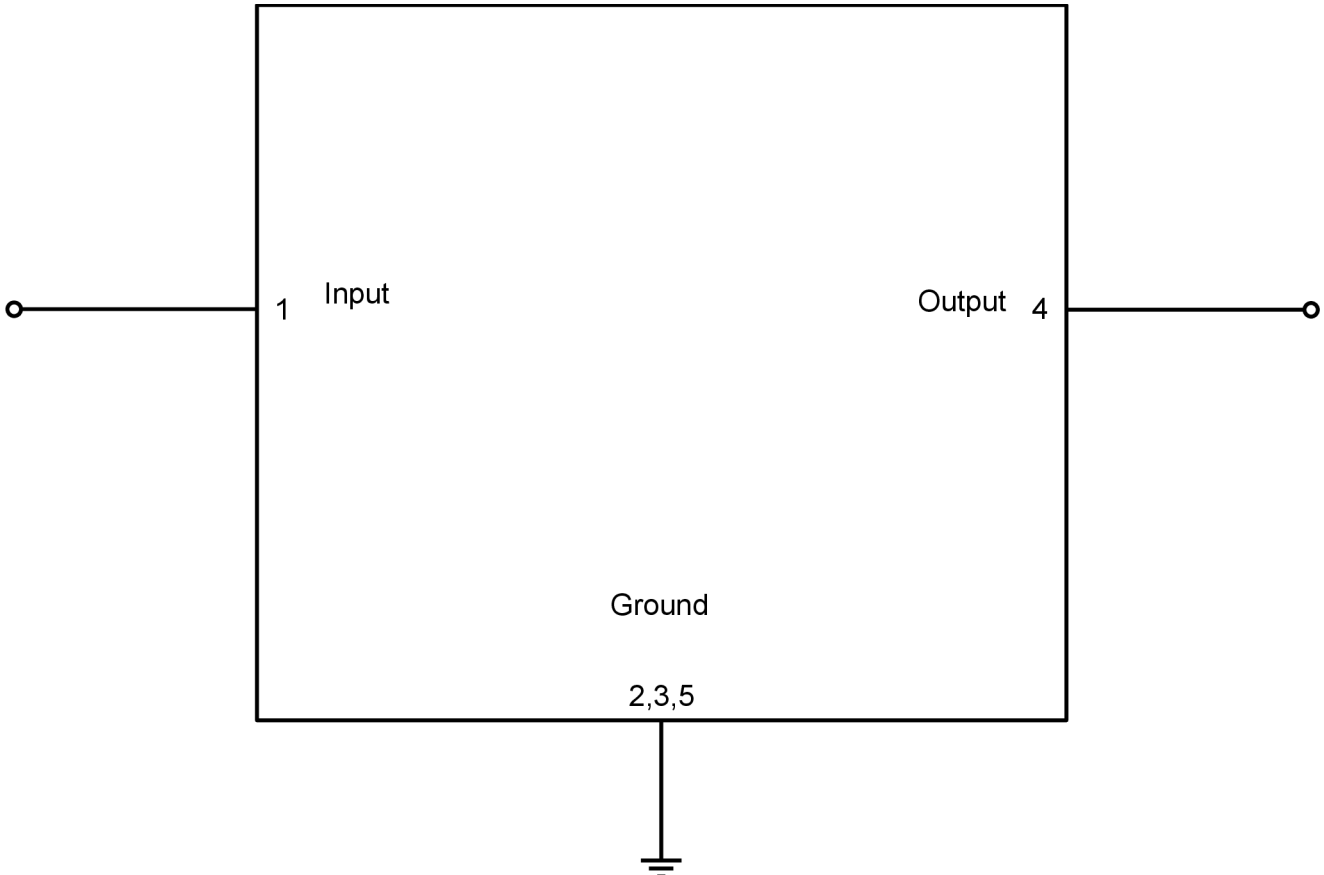
Landing pad tolerance -0.02

**Figure 2:** Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 17).

SAW components	B8814
SAW Rx filter	806

Data sheet

### 5 Matching circuit



**Figure 3:** Schematic of matching circuit. No external matching components required.

<b>SAW components</b>	<b>B8814</b>
<b>SAW Rx filter</b>	<b>806</b>

Data sheet

## 6 Characteristics

Temperature range for specification	$T_{SPEC}$	= -20 °C ... +90 °C
Input terminating impedance	$Z_{IN}$	= 50 $\Omega$
Output terminating impedance	$Z_{OUT}$	= 50 $\Omega$

Characteristics			min. for $T_{SPEC}$	typ. @+25 °C	max. for $T_{SPEC}$	
<b>Center frequency</b>		$f_C$	—	806	—	MHz
<b>Average insertion attenuation</b>	791... 821	MHz	$\alpha_{avg}$	1.4	—	dB
<b>Maximum insertion attenuation</b>	791... 821	MHz	$\alpha_{max}$	1.8	2.6 <sup>1)</sup>	dB
	791... 821	MHz		1.8	3.5	dB
<b>Amplitude ripple (p-p)</b>	791... 821	MHz	$\Delta\alpha$	1.0	2.5	dB
<b>Maximum VSWR</b>			VSWR <sub>max</sub>			
@ input port	791... 821	MHz		2.0	2.3	
@ output port	791... 821	MHz		2.0	2.3	
<b>Minimum attenuation</b>			$\alpha_{min}$			
	10... 731	MHz		40	50	dB
	760... 770	MHz		30	40	dB
	832... 862	MHz		40	43	dB
	880... 915	MHz		40	45	dB
	1710... 1785	MHz		40	45	dB
	2373... 2570	MHz		30	37	dB
	4900... 6000	MHz		20	27	dB

<sup>1)</sup> Valid for temperature  $T_{SPEC} = +25$  °C.



<b>SAW components</b>	<b>B8814</b>
<b>SAW Rx filter</b>	<b>806</b>

Data sheet

## 7 Maximum ratings

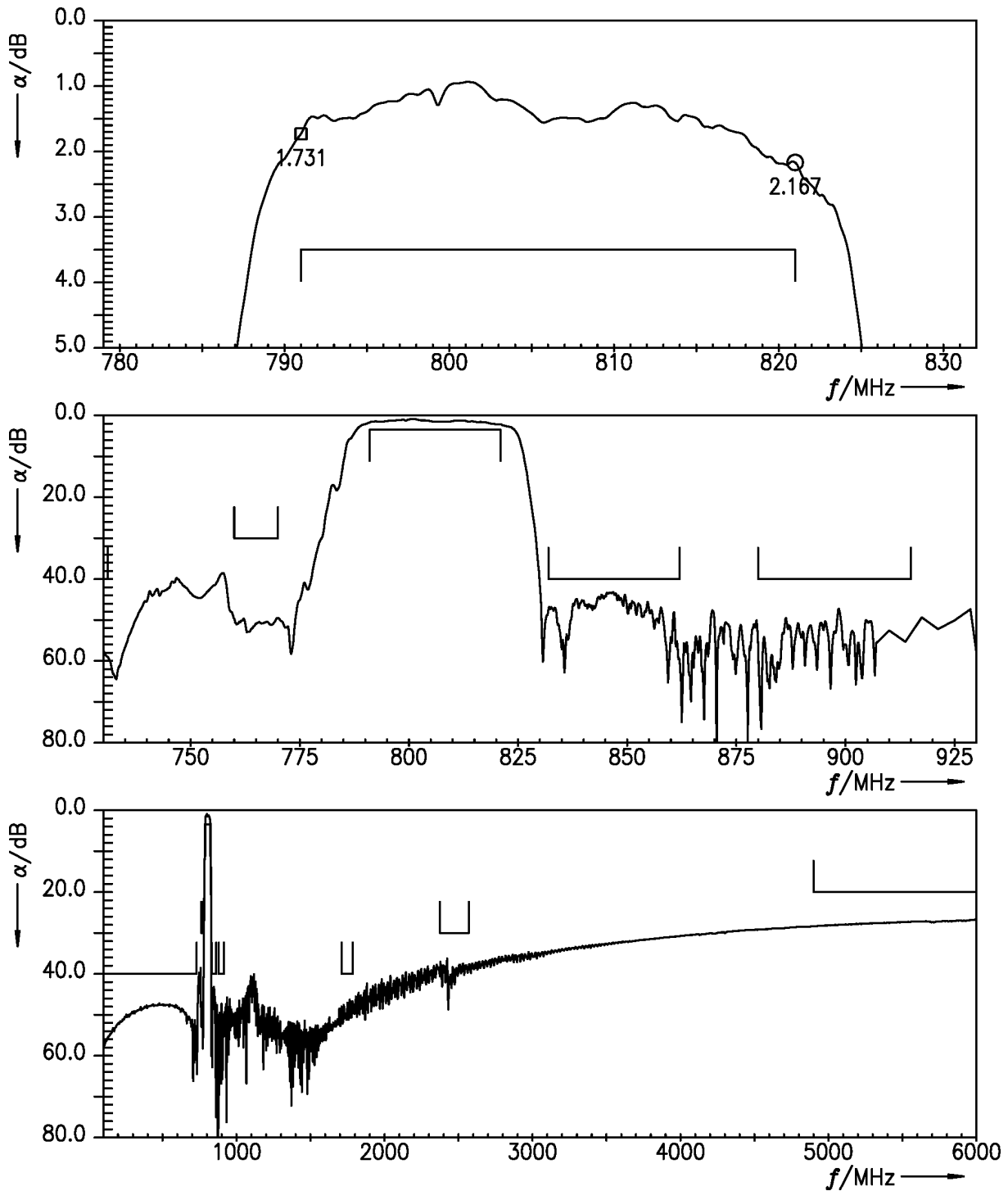
Operable temperature	$T_{OP} = -20\text{ °C} \dots +90\text{ °C}$	
Storage temperature	$T_{STG}^{1)} = -40\text{ °C} \dots +85\text{ °C}$	
DC voltage	$ V_{DC}  = 5.0\text{ V (max.)}$	
ESD voltage	$V_{ESD}^{2)} = 100\text{ V (max.)}$	Machine model. Machine model.
Input power @ input port: 832 ... 862 MHz	$P_{IN} = 15\text{ dBm (max.)}$	Continuous wave for 5000 h @ 50 °C.

<sup>1)</sup> Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

<sup>2)</sup> According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

Data sheet

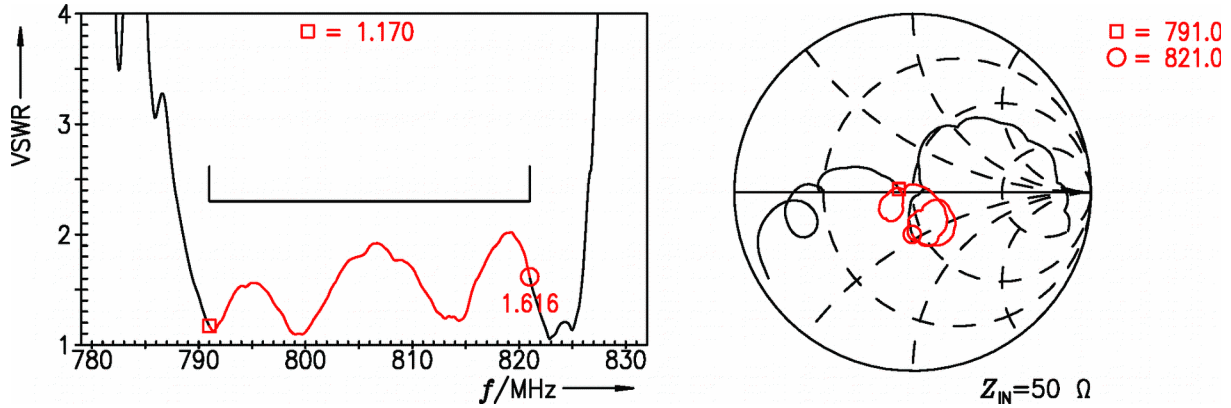
**8 Transmission coefficient**



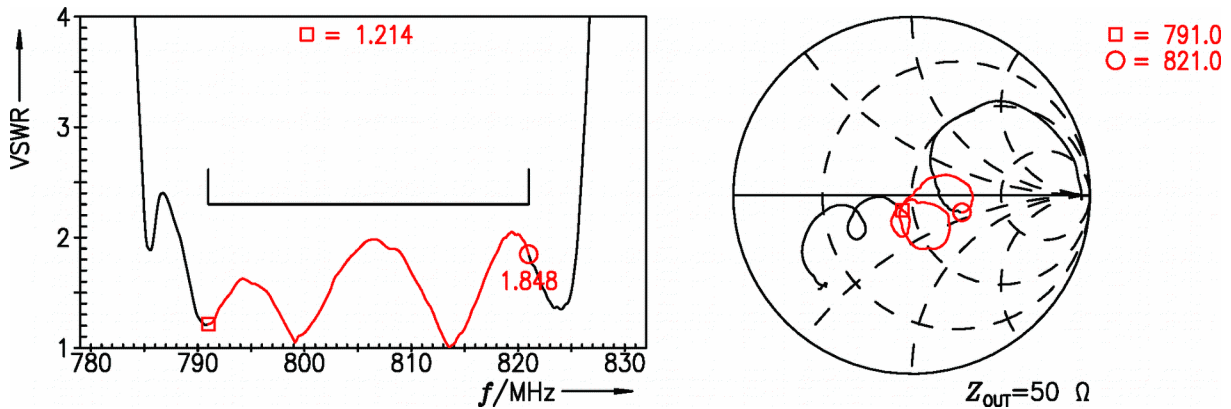
**Figure 4:** Attenuation.

Data sheet

**9 Reflection coefficients**



**Figure 5:** Reflection coefficient at IN port.



**Figure 6:** Reflection coefficient at OUT port.

Data sheet

10 Packing material

10.1 Tape

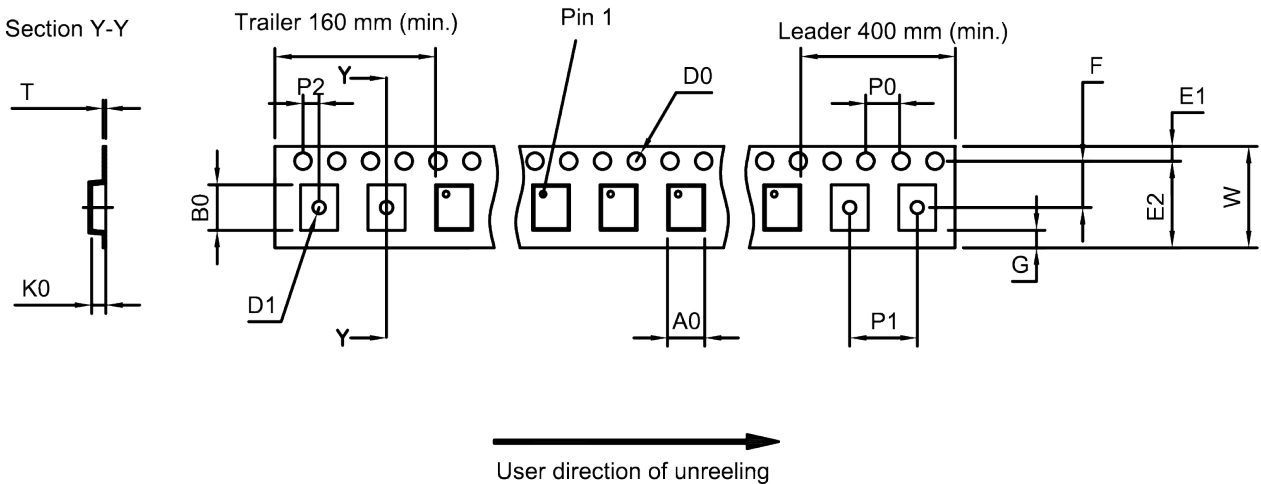


Figure 7: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A <sub>0</sub>	1.02±0.05 mm
B <sub>0</sub>	1.22±0.05 mm
D <sub>0</sub>	1.55±0.05 mm
D <sub>1</sub>	0.55±0.1 mm
E <sub>1</sub>	1.75±0.1 mm

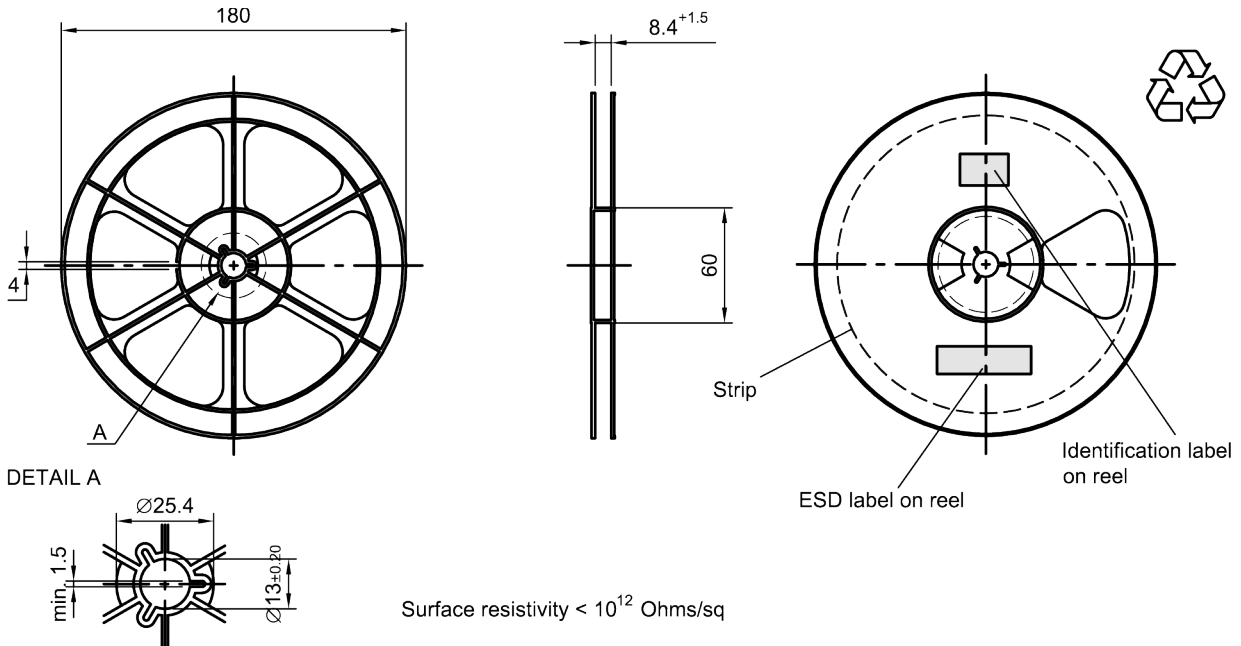
E <sub>2</sub>	6.25 mm (min.)
F	3.5±0.05 mm
G	—
K <sub>0</sub>	0.6±0.05 mm
P <sub>0</sub>	4.0±0.1 mm

P <sub>1</sub>	2.0±0.1 mm
P <sub>2</sub>	2.0±0.05 mm
T	0.25±0.03 mm
W	8.0+0.3/-0.1 mm

Table 1: Tape dimensions.

Data sheet

**10.2 Reel with diameter of 180 mm**



**Figure 8:** Drawing of reel (first-angle projection) with diameter of 180 mm.

Dimensions [mm]

X = 220+5

Y = 235+5

Sealing area 10±3

Printing on vacuumbag

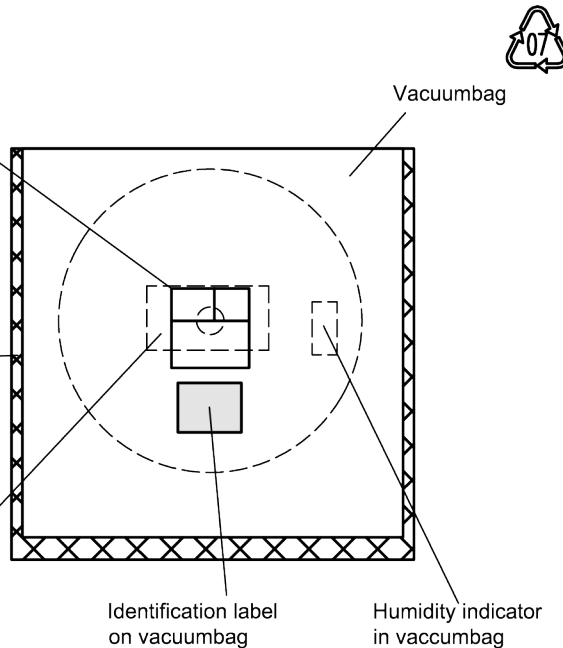
Vacuumbag

Sealing area

Drypack in vacuumbag

Identification label on vacuumbag

Humidity indicator in vacuumbag



**Figure 9:** Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

Data sheet

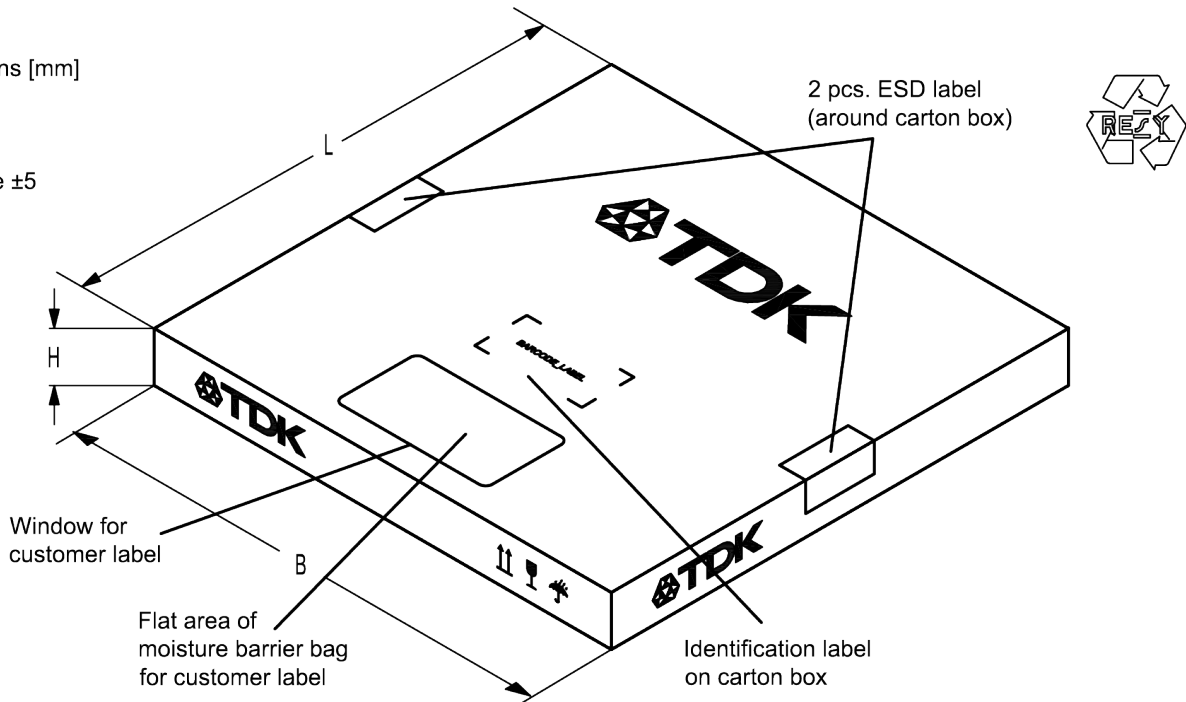
Dimensions [mm]

L = 188

B = 188

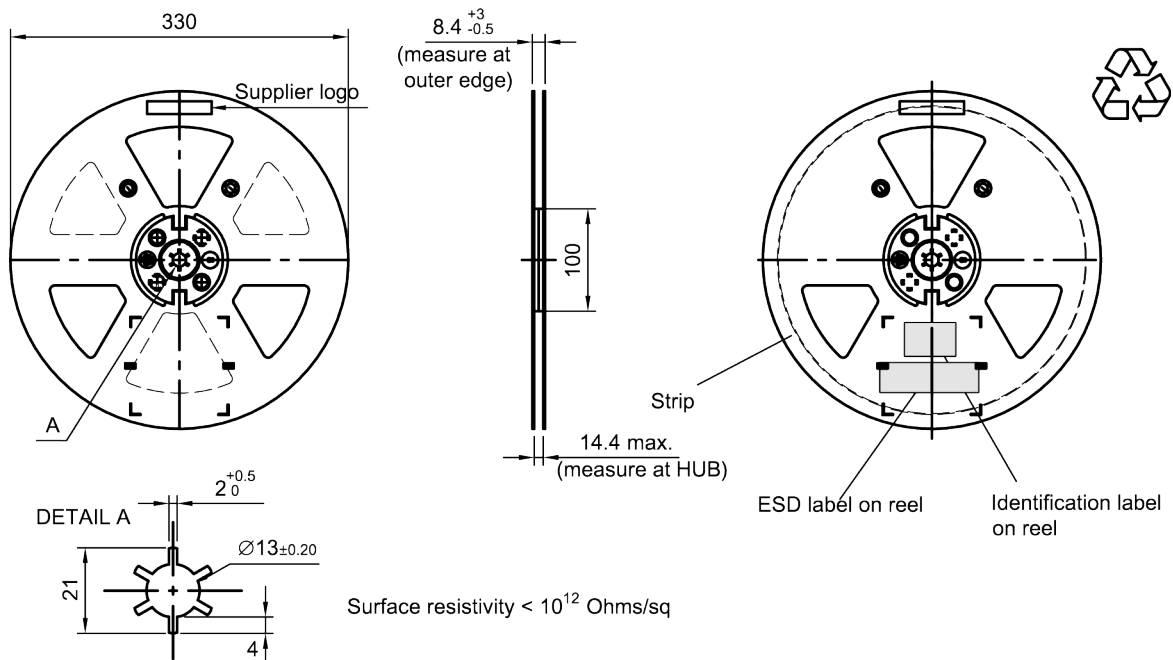
H = 30

Tolerance ±5



**Figure 10:** Drawing of folding box for reel with diameter of 180 mm.

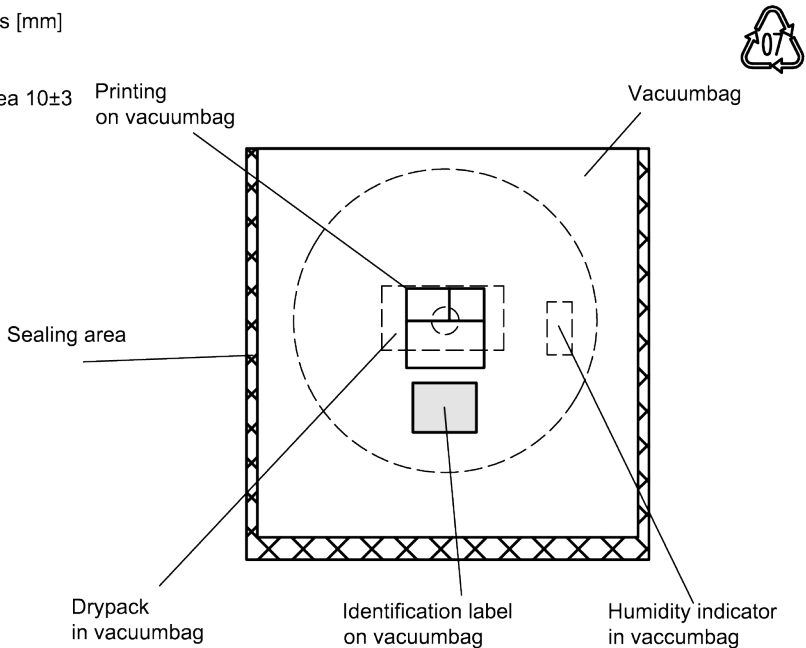
**10.3 Reel with diameter of 330 mm**



**Figure 11:** Drawing of reel (first-angle projection) with diameter of 330 mm.

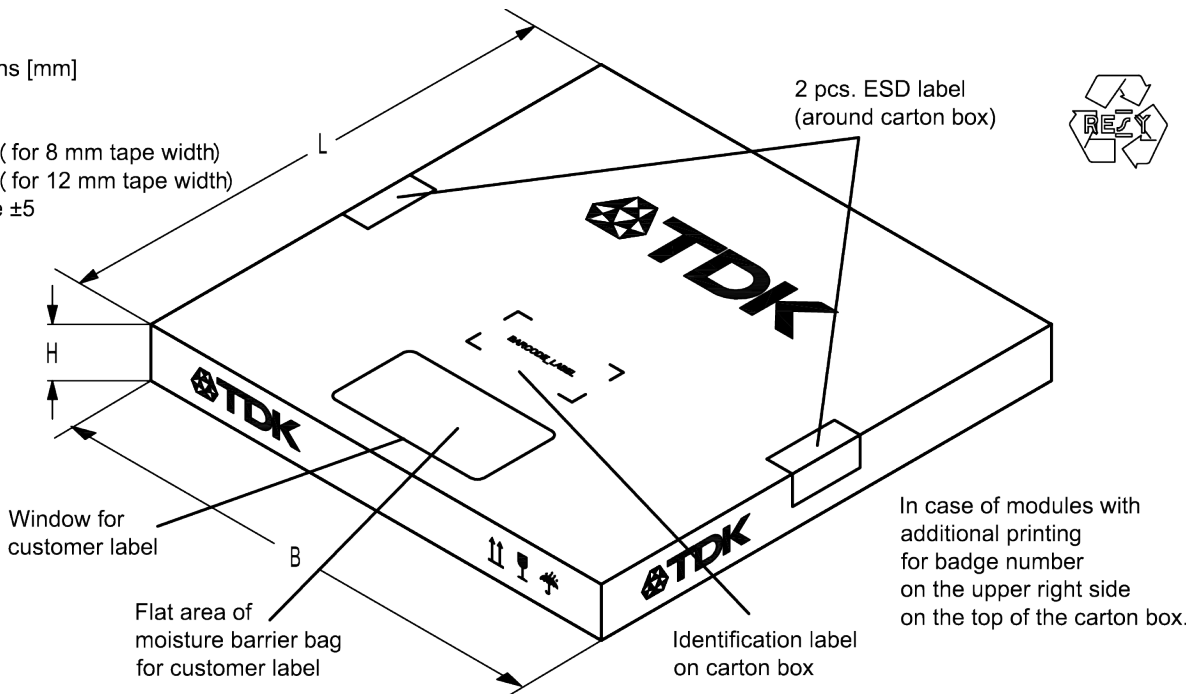
Data sheet

Dimensions [mm]  
 X = 400±5  
 Y = 418±5  
 Sealing area 10±3



**Figure 12:** Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

Dimensions [mm]  
 L = 335  
 B = 338  
 H = 36 ( for 8 mm tape width)  
 40 ( for 12 mm tape width)  
 Tolerance ±5



**Figure 13:** Drawing of folding box for reel with diameter of 330 mm.

Data sheet

## 11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

### ■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

$$\begin{array}{rcl} \mathbf{16J} & \Rightarrow & \mathbf{1234} \\ \mathbf{1} \times 32^2 + \mathbf{6} \times 32^1 + \mathbf{18} (=J) \times 32^0 & = & \mathbf{1234} \end{array}$$

The BASE32 code for product type B8814 is 8KE.

### ■ Lot number:

The last 5 digits of the lot number, e.g., **12345**, are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

$$\begin{array}{rcl} \mathbf{5UY} & \Rightarrow & \mathbf{12345} \\ \mathbf{5} \times 47^2 + \mathbf{27} (=U) \times 47^1 + \mathbf{31} (=Y) \times 47^0 & = & \mathbf{12345} \end{array}$$

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

**Table 2:** Lists for encoding and decoding of marking.



SAW components	B8814
SAW Rx filter	806

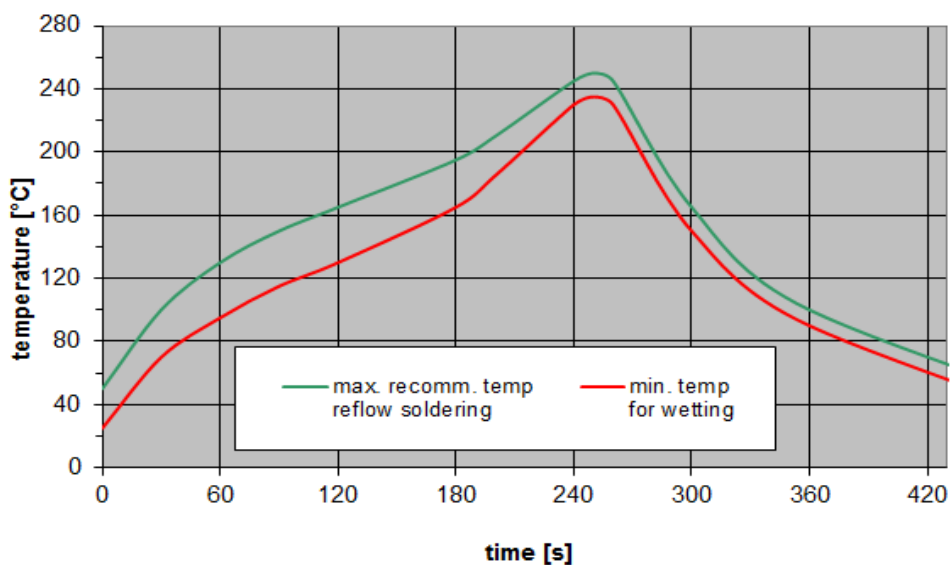
Data sheet

## 12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3<sup>rd</sup> edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature $T_{peak}$	250 °C +0/-5 °C
wetting temperature $T_{min}$	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

**Table 3:** Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 14:** Recommended reflow profile for convection and infrared soldering – lead-free solder.

<b>SAW components</b>	<b>B8814</b>
<b>SAW Rx filter</b>	<b>806</b>

Data sheet

### 13 Annotations

#### 13.1 Matching coils

See TDK inductor pdf-catalog <http://www.tdk.co.jp/tefe02/coil.htm#aname1> and Data Library for circuit simulation <http://www.tdk.co.jp/etvcl/index.htm>.

#### 13.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

#### 13.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local EPCOS sales office.

#### 13.4 Ordering codes and packing units

Ordering code	Packing unit
B39811B8814P810	15000 pcs
B39811B8814P810S 5	5000 pcs

**Table 4:** Ordering codes and packing units.

Data sheet

## 14 Cautions and warnings

### 14.1 Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under [www.epcos.com/orderingcodes](http://www.epcos.com/orderingcodes).

### 14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

### 14.3 Moldability

Before using in overmolding environment, please contact your local EPCOS sales office.

### 14.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on EPCOS internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of EPCOS, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

#### Projection method

Unless otherwise specified first-angle projection is applied.

## Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet ([www.epcos.com/material](http://www.epcos.com/material)). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available.  
The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
6. Unless otherwise agreed in individual contracts, **all orders are subject to the current version of the “General Terms of Delivery for Products and Services in the Electrical Industry” published by the German Electrical and Electronics Industry Association (ZVEI)**.
7. The trade names EPCOS, Alu-X, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CSSP, CTVS, DeltaCap, DigiSiMic, DSSP, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PQSine, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SIP5D, SIP5K, TFAP, ThermoFuse, WindCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at [www.epcos.com/trademarks](http://www.epcos.com/trademarks).

单击下面可查看定价，库存，交付和生命周期等信息

[>>RF360 / Qualcomm](#)